

つきまわり性に優れる6価クロムめっき用添加剤

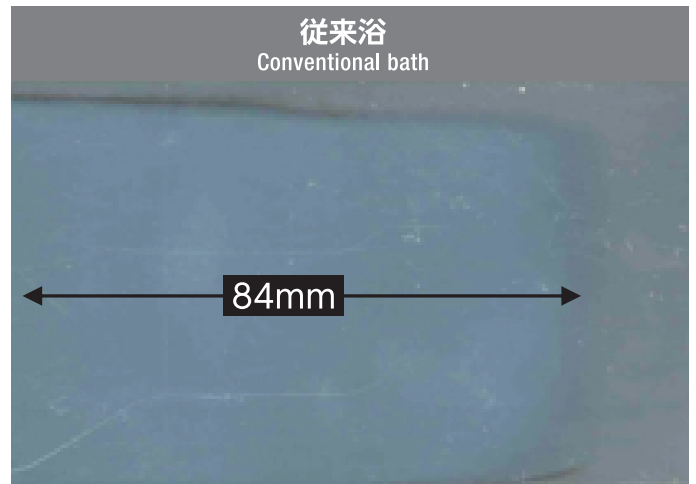
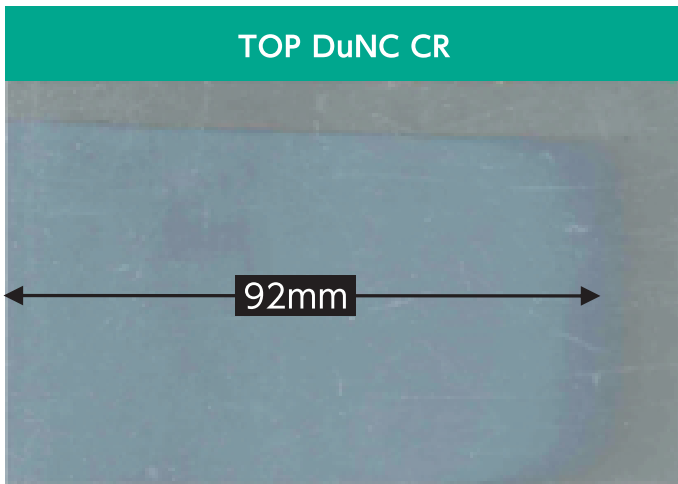
Additive for Hexavalent Chromium Plating with Great Covering Performance

TOP DuNC CR

- **つきまわり性に優れる**
Great covering power
- **浴中のフッ化物濃度が低く、陽極が溶解しにくい**
Fluoride concentration is low, prevent anode dissolution

優れたつきまわり性

Great covering power



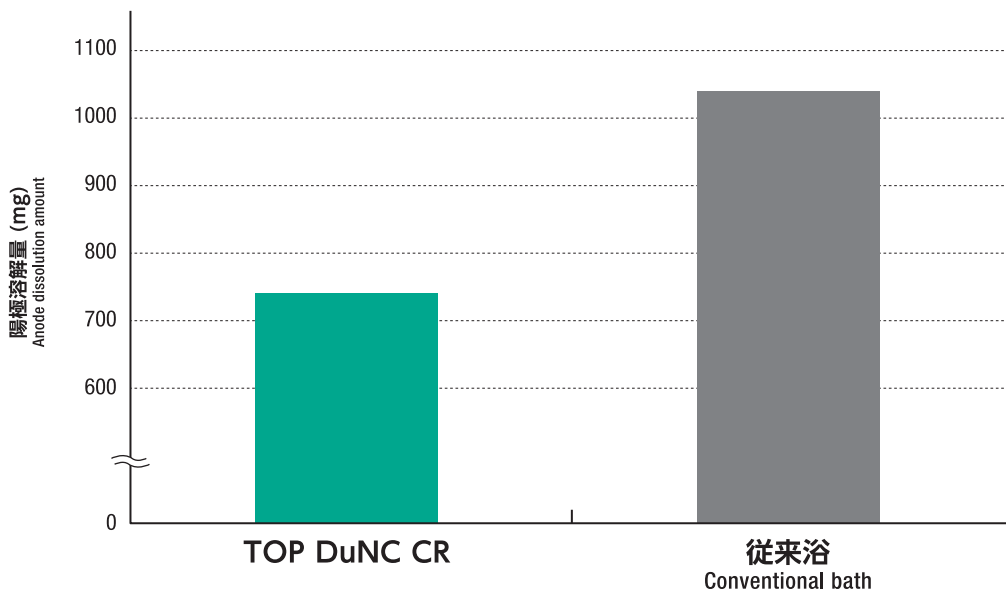
つきまわりの比較
Comparison of covering performance

下地: 光沢ニッケルめっき, 添加剤にTOP DuNC BN使用
Undercoat: Bright nickel plating film containing TOP DuNC BN as additive

ハルセル試験条件: 5A, 2分
Hull-cell test condition min

陽極の溶解量が少ない

Prevent anode dissolution



※鉛-スズ5%の陽極に陽極電流密度10A/dm²で5分電解→5分停止のサイクルを24時間繰り返し、陽極の重量変化を測定(陽極面積0.2dm²)
*Prepare Pb-Sn5% anode (0.2dm²) and conduct plating for 5 min at 10A/dm² of anode current density, then stop plating and wait for 5 min.
Repeat the procedure for 24 hours to evaluate anode dissolution amount.